

SST-05-IR-850 nm

Surface Mount Series

Infrared LED



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Features

- High Power Infrared LED with typical 850 nm wavelength
- 20 and 35 degree half-angle dome for high-irradiance and simpler optical design for directional applications
- Operation at up to 1A CW and 2A pulse
- 850 nm typical centroid wavelength
- Built-in ESD protection
- Low Thermal Resistance
- Suitable for all SMT Assembly Methods
- RoHS and REACH compliant

Applications

- Surveillance Systems / CCTV
- Iris and Face Recognition
- License Plate Scanning
- Automotive Sensing
- Machine Vision
- Night Vision
- Replacement of legacy 5 mm IR LEDs for improved designs



Technology Overview

Luminus SST-05-IR-850nm LEDs benefit from innovations in device technology, chip packaging and thermal management. This suite of technologies give engineers and system designers the freedom to develop solutions both high in power and efficiency.

Reliability

Luminus SST-05-IR-850nm LEDs have passed a rigorous suite of environmental and mechanical stress tests, including mechanical shock, vibration, temperature cycling and humidity. They are fully qualified for use in a wide range of high performance and high efficacy applications.

REACh & RoHS Compliance

The Luminus SST-05-IR-850nm LED is compliant to the Restriction of Hazardous Substances Directive or RoHS. The restricted materials including lead, mercury cadmium hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ether (PBDE) are not used.

Understanding Luminus SST-05-IR-850nm LED Test Specifications

Every Luminus LED is fully tested to ensure it meets the high quality standards customers have come to expect from Luminus products.

Testing Temperature

Luminus SST-05-IR-850nm LEDs are tested and binned at 25°C junction temperature. Temperature curves are provided to allow users to scale the data for actual operating temperature conditions.



Product Ordering and Shipping Part Number Nomenclature

All SST-05-IR-850nm products are packaged and labeled with part numbers as outlined in below. When shipped, each reel will contain only a single flux wavelength and Vf bin. The part number designation is as follows:

Products	Ordering Part Number	Description
SST-05-IR-Bxx	SST-05-IR-Bxx-F###	SST-05 surface mount infrared LED

SST	— 05 —	IR		Bxx	— F###
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Product Family	Chip Area	Color	Package Configuration	Bin Kit ^{1,2}
SST - Ceramic Surface Mount package w/ encapsulation	05: 0.5 mm²	IR = Infrared	B40 - 40 deg Beam Angle B70 - 70 deg Beam Angle Ceramic 3.45 mm x 3.45 mm See Pages 6-7 for Detailed Drawings	See below for flux and wavelength binning information

Peak Wavelength	Minimum Flux Bin (mW)	Lens Angle	Ordering Part Number
850	235	40	SST-05-IR-B40-J850
020	235	70	SST-05-IR-B70-J850

Flux Bins¹

	Radiometric Power	at 350mA, t _p =20ms	Correlated radiant intensity at 1.0A, t_p =20ms - B40	
Bin Code	Minimum Flux (mW)	Maximum Flux (mW)	Min. Radiant Intensity (mW/sr)	Max. Radiant Intensity (mW/sr)
J	235	265	697	786
К	265	295	786	875
L	295	325	875	964
М	325	355	964	1053

Wavelength Bins¹

Bin Code	Minimum Peak Wavelength (nm)	Maximum Peak Wavelength (nm)	
850	840	870	





Optical and Electrical Characteristics

Optical and Electrical Characteristics¹

Devenestor	Symbol	Package Type		Unit
Parameter		B40	B70	Unit
Forward Current	ا _f	35	50	mA
Output Power Typical	PO	29	95	mW
Output Power at 1.0A, t =20ms (typ.)	PO _{1.0A}	80	00	mW
Radiant Intensity at 1.0A, t_=20ms (typ.)	f _e	875	500	mW/sr
Minimum Forward Voltage ¹	V _{fmin}	1.	2	V
Forward Voltage Typical	V _f	1.	6	V
Maximum Forward Voltage ¹	V _{f max}	2.	0	V
Viewing Angle	2 Ø _{1/2}	40	70	deg
Peak Wavelength Typical	λ _p	85	50	nm
Centroid Wavelength Typical	λ	86	50	nm
FWHM Typical	Δλ _{1/2}	3	0	nm
Temperature Coefficient of Foward voltage	TC _{VF}	-1	.5	mV/ °C
Temperature Coefficient of Radiometric Power	TC _{PO}	-0	.3	%/ °C
Temperature Coefficient of Wavelength	TC _I	0.3		nm/ °C
Thermal Resistance (Electrical)	R _{TH}	9.	2	°C/W

Note 1: Binning based on operation at a current of 350mA, 20ms single pulse and a constant junction temperature of $T_j = 25$ °C. Parts are binned and shipped in 0.2V V fincrements.



Optical and Electrical Characteristics

Absolute Maximum Ratings²

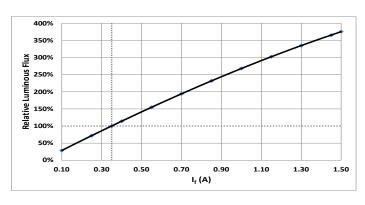
Parameter	Symbol	Rating	Unit
Forward Current ^{3,4}	I	1.0	A
Power Dissipation	PD	2.5	W
Reverse Voltage	VR	5	V
Storage Temperature	Тѕтд	-40~100	°C
Junction Temperature ^{3,4}	ΤJ	115 ℃	°C
Soldering Temperature	Tsld	JEDEC 020 , 260 °C	
ESD Sensitivity (HBM)	VB	6000	V

Note 2: To prevent damage refer to operating conditions and derating curves for appropriate maximum operating conditions

- Note 3: Luminus SST-05-IR-850nm LEDs *ar*e designed for operation up to an absolute maximum forward drive current as specified above. Product lifetime data is specified at typical forward drive currents. Sustained operation at absolute maximum currents will result in a reduction of device lifetime compared to typical forward drive currents. Actual device lifetimes will also depend on junction temperature.
- Note 4: Maximum operating case temperature combined with maximum drive current defines the total maximum operating condition for the device. To prevent damage, please operate devices within specified conditions.
- Note 5: Caution must be taken not to stare at the light emitted from these LEDs. Under special circumstances, the high intensity could damage the eye.

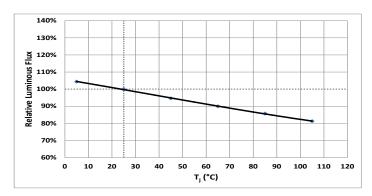


Optical and Electrical Characteristics

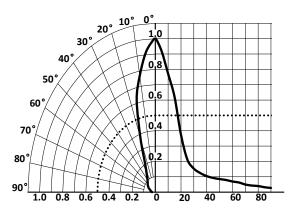


Relative Output Flux vs. Forward Current

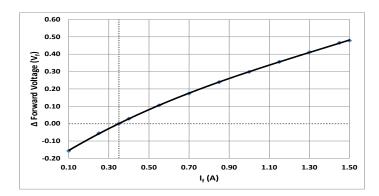
Relative Output Flux vs. Temperature



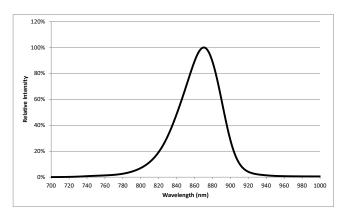
Typical Polar Radiation Plot - B40



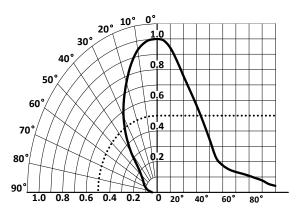
Relative Voltage vs Forward Current



Typical Spectra



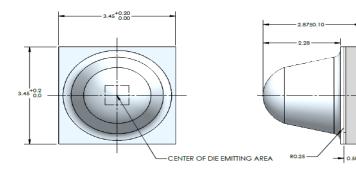
Typical Polar Radiation Plot - B70





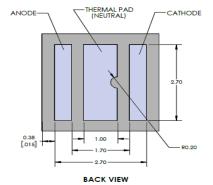


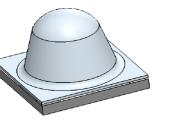
Mechanical Dimensions - B40 Package

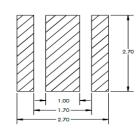


FRONT VIEW

SIDE VIEW

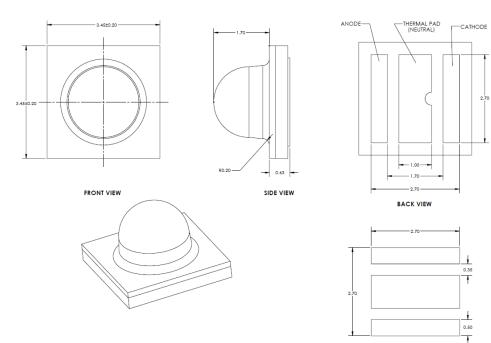






Recommended PCB Solder Pad

Mechanical Dimensions - B70 Package

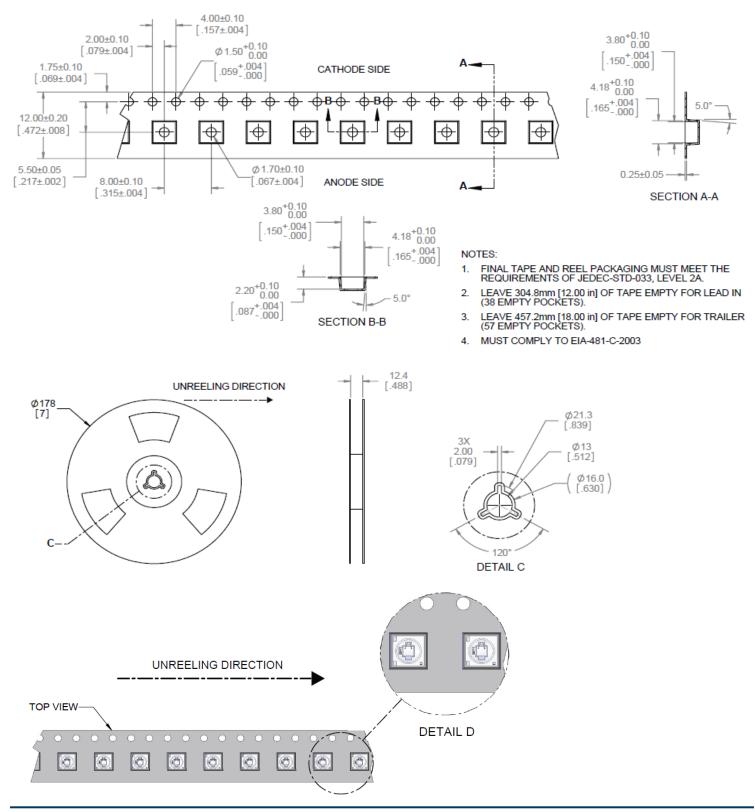


Recommended PCB Solder Pad

SST-05-IR-850 nm Product Datasheet

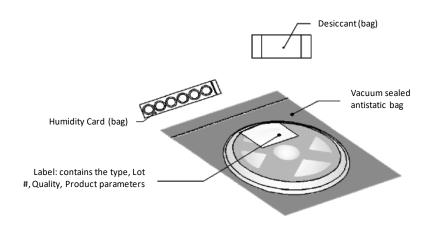


Tape and Reel





Reel Packaging (500 parts per reel)



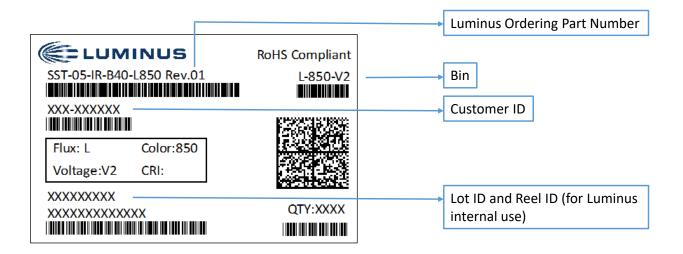
Reel Label

		Luminus Internal Part Number
LUMINUS 113407 Rev.01 L-850-V2 -	RoHS Compliant	Bin
SST-05-IR-B40	622215222	Customer Part Number Root
Flux: LColor:850Voltage:V2CRI:		
	QTY:500	Lot ID and Reel ID (for Luminus internal use)

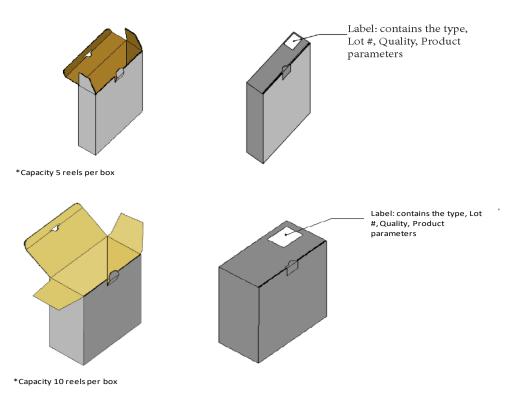




Shipping Label

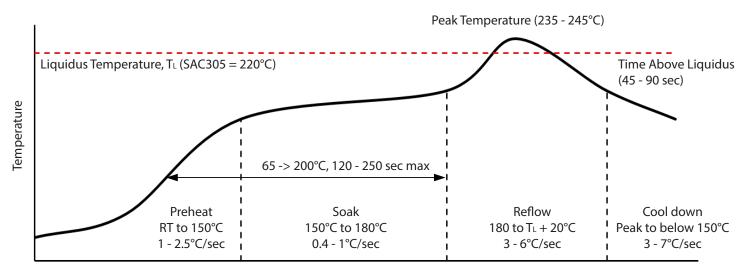


Box Packaging Information





Soldering Profile



Time

SMT Rework Guideline	Manual Hotplate Reflow Hot Air Gun Reflow		
Heating Time	< 60 sec		
Hotplate Temperature	< 245°C	< 150°C	

Note:

- 1. Product complies to Moisture Sensitivity Level 1 (MSL 1).
- 2. The numbers in the table are specific to SAC305. Luminus recommends using an SAC305 solder paste with a no-clean flux for RoHS compliant products.
- 3. During the pick and place process, axial forces on the dome (or window) should not exceed 0.5 Newtons (N).
- 4. Use of a multi-zone IR reflow oven with a nitrogen blanket is recommended.
- 5. Time-temperature profile of the reflow process showing the four functional profile zones are defined in IPC-7801. Temperature is referenced to the center of the PCB.
- 6. Luminus recommends to use the solder paste data sheet information as a starting point in time-temperature process development.
- 7. These are general guidelines. Consult the solder paste manufacturer's datasheet for guidelines specific to the alloy and flux combination used in your application. For more information, please refer to:

https://luminusdevices.zendesk.com/hc/en-us/articles/360060306692-How-do-I-Reflow-Solder-Luminus-SMD-Components-

8. For any technical questions about soldering process, please contact Luminus at techsupport@luminus.com.



Precautions

Static Electricity:

This product is sensitive to static electricity, and care should be taken when handling them. Static electricity or surge voltage will damage the LEDs. It is recommended to wear an anti-electrostatic wristband or anti-electrostatic gloves when handling the LEDs. All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken to isolate LED processing equipment from potential sources of voltage surges.

Reference: APN-002815 Electrical Stress Damage to LEDs and How to Prevent It

Corrosion Robustness:

The LEDs passed the test: AEC-Q102 Rev A – Test Group C #12 - Corrosion Class A, without any significant change in electrical and optical characteristics.

Test condition: 25°C / 90 % RH / 15 ppm H2S / 14 days (stricter than IEC 60068-2-43)

Optical and Electrical Pass/Fail criteria as defined in AEC-Q102 Rev A – "Appendix 5: Parametric Test Requirements and Failure Criteria" Corrosion test: Class 3B (discoloration possible)



History of Changes

Rev	Date	Description of Change
01	10/15/2018	Initial Release
02	01/01/2019	Added B70 package type
03	03/26/2024	Added B70 package drawing

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